



Application Note AN-PAN-1012

# Online analysis of nickel ion and hypophosphite content in electroless nickel plating baths

Pure nickel is a silvery-white metal that is extremely hard, corrosion-resistant, and ductile. Due to these remarkable characteristics, the metal is largely used in coatings and surface engineering with many applications. Electroless nickel plating is an autocatalytic chemical technique to deposit a layer of nickel-phosphorus alloy on the surface of a solid workpiece. The process relies on the chemical presence of a reducing agent (sodium hypophosphite) which reacts with the metal ions for deposition. However, the lifespan of the plating bath

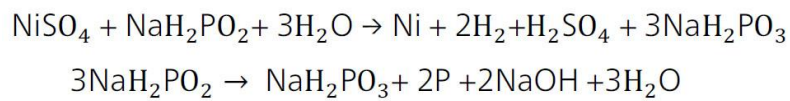
chemicals is limited so there is a critical process control requirement to monitor the chemical consumption automatically. As the bath is used for longer periods, the electrolyte becomes overloaded with reaction products which negatively affects the surface and layer characteristics of the workpieces. This Process Application Note presents a method to regularly monitor the active bath constituents in an electroless nickel plating bath to ensure an even layer of nickel-phosphorus alloy is deposited.

## INTRODUCTION

Electroless nickel plating baths facilitate the chemical reduction of nickel ions to the metal in acidic electrolyte baths. Here, sodium hypophosphite ( $\text{NaH}_2\text{PO}_2$ ) is used as the reducing agent; with its help, a very corrosion-resistant nickelphosphorus alloy is deposited on the material surface.

The decisive reaction is the chemical reduction of the nickel and hydrogen ions by the hypophosphite leading to the deposited nickel and hydrogen gas

(**Reaction 1**). Little hydrogen gas formation points to a missing or a slow nickel deposition. The quicker this reaction occurs, the lower the amount of phosphorus in the coating. On the other hand, more phosphorus is contained in the coating when the reaction is slowed down. Coatings with high amounts of phosphorus (10–14%) are very resistant to corrosion, whereas higher abrasion resistance is more readily achieved with a low phosphorus content (3–7%).

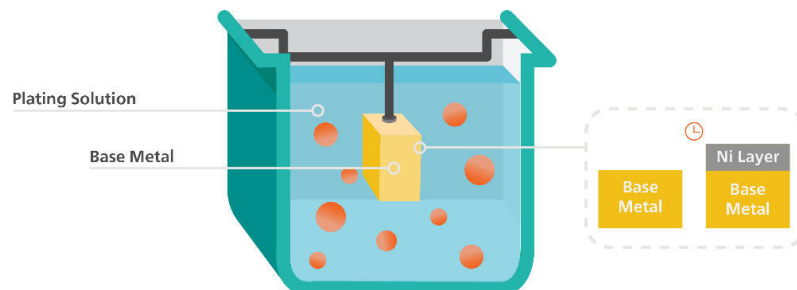


**Reaction 1.** Reaction of electroless nickel deposition.

As nickel ions and hypophosphite are continuously consumed during the deposition process, the concentrations of these components must be kept within defined tolerances and continuously replenished to maintain consistent quality in the final product.

When the plating bath is in use, the concentrations of sulfate and sodium phosphite ( $\text{NaH}_2\text{PO}_3$ ) steadily increase; this becomes the limiting factor when the bath is in use for a long time. As more nickel is

deposited than phosphorus, more sulfuric acid than sodium hydroxide is formed as the process continues. This leads to a decrease in pH during nickel deposition which must be increased again by the addition of sodium hydroxide or ammonia. Only exact and reproducible determination of the process-relevant parameters can ensure that the consumed bath components can be replenished correctly to guarantee optimal process control.



**Figure 1.** Schematic diagram of the electroless nickel plating process.

## APPLICATION

Online monitoring of the pH, nickel, and hypophosphite content is possible with the **2060 Process Analyzer** from Metrohm Process Analytics (Figure 2). All liquid handling steps such as taking sample aliquots, dosing of reagents, titration, and cleaning are performed by pumps and burets controlled by the process analyzer.

The analysis consists of transferring a sample aliquot either to the vessel for alkalinity and nickel analysis or to the vessel for sodium hypophosphite determination.

The 2060 Process Analyzer enables simultaneous, monitoring of diverse bath parameters with a single measurement, increasing measurement frequency. Nickel and pH are determined by online titration (Figure 3), and sodium hypophosphite is determined by potentiometric titration using a platinum electrode.



Figure 2. 2060 Process Analyzer

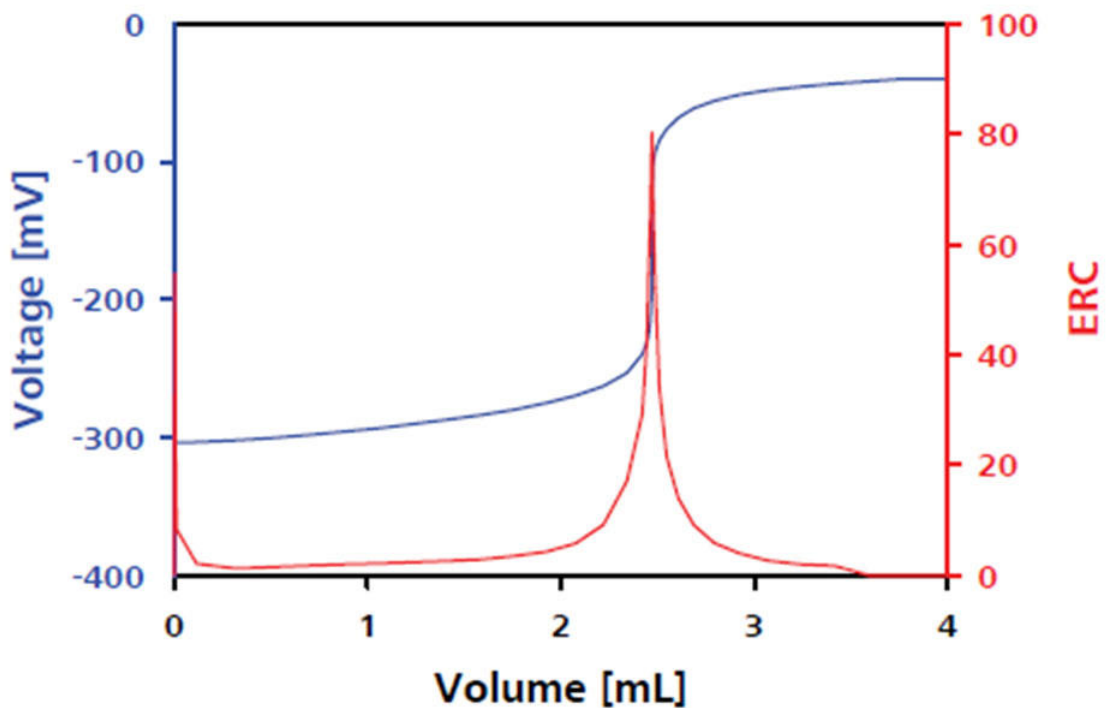


Figure 3. Back-titration curve of iodine using thiosulfate. ERC: Equivalence point Recognition Criterion.

Manual data collection can affect product quality, reduce yield, and expose personnel to hazardous conditions. This robust process analyzer has the flexibility to automatically recognize the titration endpoint to guarantee reproducibility of results, and high reliability and dispense accuracy of the bath

constituents. The 2060 Process Analyzer can be programmed to acquire data at regular intervals without needing to wait for laboratory results, and out-of-specification readings can immediately inform operators to take direct action.

**Table 1.** Parameters to monitor in electroless nickel plating baths

Analyte	Range
Ni as nickel sulfate (NiSO <sub>4</sub> )	<10 g/L
NaH <sub>2</sub> PO <sub>2</sub>	1–12 %
pH	4.5–5.0

## CONCLUSION

Knowing the exact concentration of the active bath constituents in an electroless nickel plating bath is crucial since early measures can be taken if necessary. This includes the timely replenishment of the consumed components to ensure an even coating

deposition and the separation of formed contaminants. Online monitoring of plating baths ensures the quality of the final product, meaning higher yields and less downtime as well as a reduction in operation costs by extending the bath life.

## FURTHER READING

[Determination of acids, bases, and aluminum: galvanic industry – metal surface treatment](#)

[Online and atline analysis of acids and iron in pickling baths](#)

## BENEFITS FOR TITRATION IN PROCESS

- Increased final product quality and metal turnover (MTO) due to online determination of bath parameters
- Fully automated diagnostics – automatic alarms for when samples are out of specification parameters
- Safer working environment and automated sampling



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## CONFIGURATION



### 2060 Process Analyzer

The 2060 Process Analyzer is an online wet chemistry analyzer that is suitable for countless applications. This process analyzer offers a new modularity concept consisting of a central platform, which is called a «basic cabinet».

The basic cabinet consists of two parts. The upper part contains a touch screen and an industrial PC. The lower part contains the flexible wet part where the hardware for the actual analysis is housed. If the basic wet part capacity is not sufficient enough to solve an analytical challenge, then the basic cabinet can be expanded to up to four additional wet part cabinets to ensure enough space to solve even the most challenging applications. The additional cabinets can be configured in such a way that each wet part cabinet can be combined with a reagent cabinet with integrated (non-contact) level detection to increase analyzer uptime.

The 2060 process analyzer offers different wet chem techniques: titration, Karl Fischer titration, photometry, direct measurement and standard additions methods.

To meet all project requirements (or to meet all your needs) sample preconditioning systems can be provided to guarantee a robust analytical solution. We can provide any sample preconditioning system, such as cooling or heating, pressure reduction and degassing, filtration, and many more.